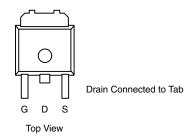


Vishay Siliconix

N-Channel 100 V (D-S), 150 °C MOSFET

| PRODUCT SUMMARY | | | | |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) ^a | Q _g (Typ.) | |
| 100 | 0.0185 at V _{GS} = 10 V | 50 | 48 nC | |

TO-252



Ordering Information:

SUD50N10-18P-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_a and UIS Tested
- Material categorization:
 For definitions of compliance please see www.vishay.com/doc?99912

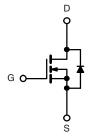


RoHS COMPLIANT HALOGEN

FREE

APPLICATIONS

- Primary Side Switch
- Isolated DC/DC Converter



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS | S T _A = 25 °C, unles | ss otherwise no | ted | | |
|----------------------------------------------------|----------------------------------------|-----------------------------------|------------------|----|------|
| Parameter | Symbol | Limit | Unit | | |
| Drain-Source Voltage | V _{DS} | 100 | V | | |
| Gate-Source Voltage | | V _{GS} | | | ± 20 |
| | T _C = 25 °C | | 50 ^a | | |
| Continuous Drain Current (T. – 150 °C) | T _C = 100 °C | | 33.4 | | |
| Continuous Drain Current (T _J = 150 °C) | T _A = 25 °C | I _D | 7.8 ^b | | |
| | T _A = 100 °C | | 5 ^b | | |
| Pulsed Drain Current | | I _{DM} | 100 | A | |
| Continuous Source Drain Diade Current | T _C = 25 °C | 1 | 50 ^a | | |
| Continuous Source-Drain Diode Current | T _A = 25 °C | I _S | 1.7 ^b | | |
| Single Pulse Avalanche Current | L = 0.1 mH | I _{AS} | 45 | | |
| Avalanche Energy | | E _{AS} | 101 | mJ | |
| | T _C = 25 °C | | 113.6 | | |
| Maximum Power Dissipation | T _C = 100 °C | | 45.5 | w | |
| | T _A = 25 °C | - P _D | 2.5 ^b | v | |
| | T _A = 100 °C | | 1 ^b | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|------------------------------------------|--------------|-------------------|---------|---------|--------------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^b | Steady State | R _{thJA} | 40 | 50 | °C/W | |
| Maximum Junction-to-Case | Sleady State | R_{thJC} | 0.85 | 1.1 | O/ VV | |

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

SUD50N10-18P-GE3

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| SPECIFICATIONS ($T_J = 25$ ° | C, unless o | otherwise noted) | | | | | |
|-----------------------------------------------|-------------------------|------------------------------------------------------------------------------------|------|--------|--------|-------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 100 | | | V | |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 250 μA | | 110 | | mV/°C | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | | | - 12.5 | | | |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 2.5 | | 5 | V | |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| Zoro Coto Voltogo Dusin Comunit | I | V _{DS} = 100 V, V _{GS} = 0 V | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ | | | 50 | μΑ | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 50 | | | Α | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 15 A | | 0.0150 | 0.0185 | Ω | |
| Forward Transconductance ^a | g _{fs} | V _{DS} = 15 V, I _D = 15 A | | 33 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 2600 | | pF | |
| Output Capacitance | C _{oss} | $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 230 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 80 | | | |
| Total Gate Charge | Qg | | | 48 | 75 | | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$ | | 16 | | nC | |
| Gate-Drain Charge | Q _{gd} | | | 13 | | | |
| Gate Resistance | R_g | f = 1 MHz | | 1.6 | 2.5 | Ω | |
| Turn-On Delay Time | t _{d(on)} | | | 12 | 20 | | |
| Rise Time | t _r | $V_{DD} = 50 \text{ V, R}_{1} = 1 \Omega$ | | 10 | 20 | ns | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | | 18 | 35 | | |
| Fall Time | t _f | | | 8 | 15 | | |
| Drain-Source Body Diode Characteris | stics | | | | | | |
| Continuous Source-Drain Diode | I _S | T _C = 25 °C | | | 50 | | |
| Pulse Diode Forward Current ^a | I _{SM} | | | | 100 | A | |
| Body Diode Voltage | V _{SD} | I _S = 15 A | | 0.85 | 1.5 | V | |
| Body Diode Reverse Recovery Time | t _{rr} | | | 80 | 120 | ns | |
| Body Diode Reverse Recovery Charge | Q _{rr} | $I_F = 50 \text{ A, dl/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$ | | 160 | 240 | nC | |
| Reverse Recovery Fall Time | t _a | | | 57 | | ns | |
| Reverse Recovery Rise Time | t _b | | | 23 | | | |

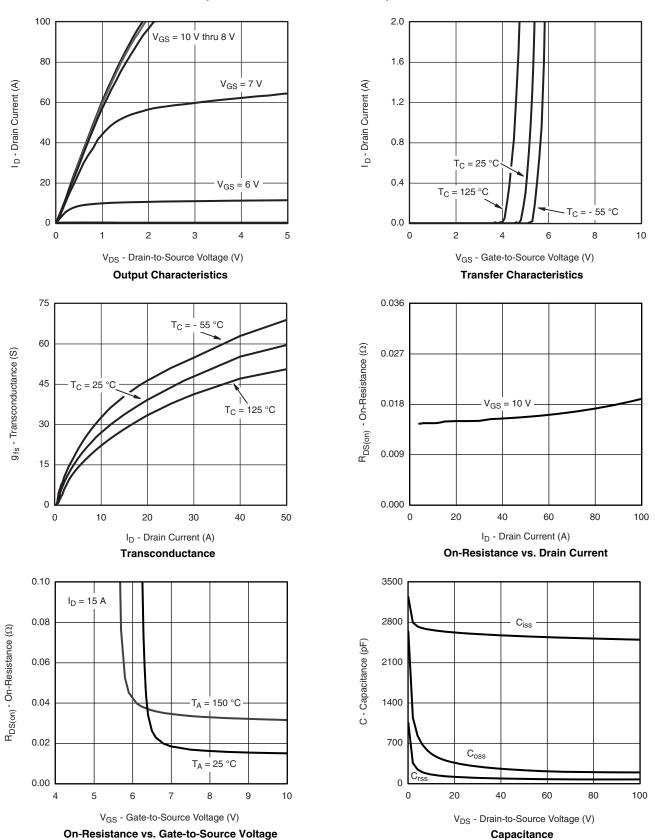
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

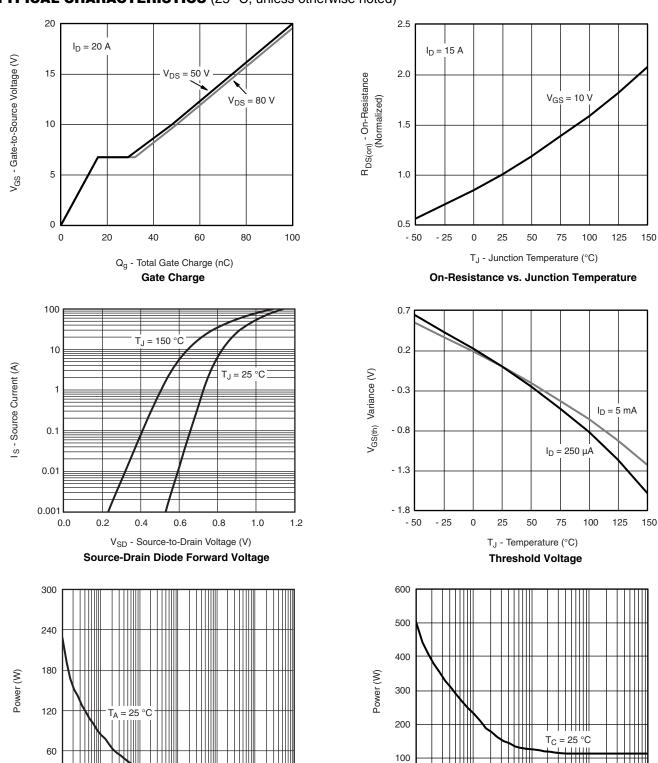


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



0.001

0.01

0.1

Time (s)

Single Pulse Power, Junction-to-Ambient

1000

0 0.001

0.01

10

10

100

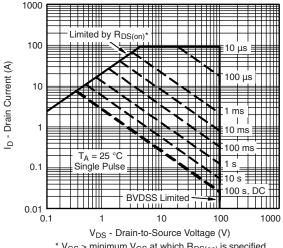
0.1

Time (s)

Single Pulse Power, Junction-to-Case

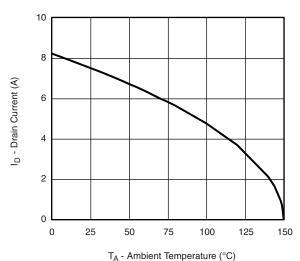


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

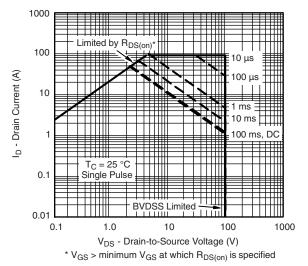


 * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

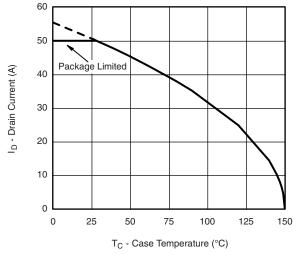
Safe Operating Area, Junction-to-Ambient



Current Derating**, Junction-to-Ambient



Safe Operating Area, Junction-to-Case

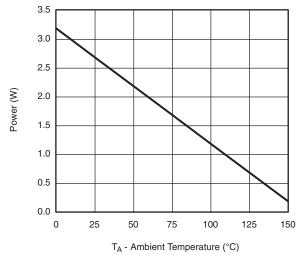


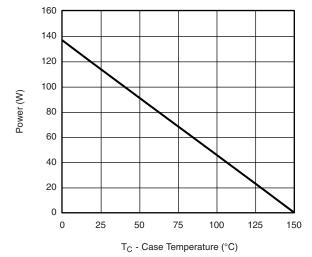
Current Derating**, Junction-to-Case

^{**} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





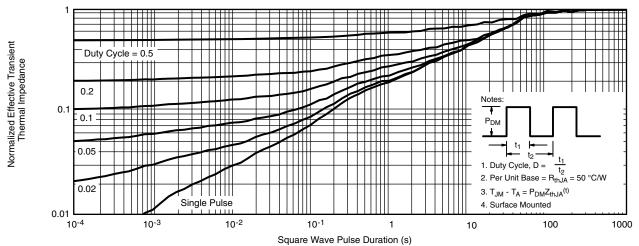
Power Derating**, Junction-to-Ambient

Power Derating**, Junction-to-Case

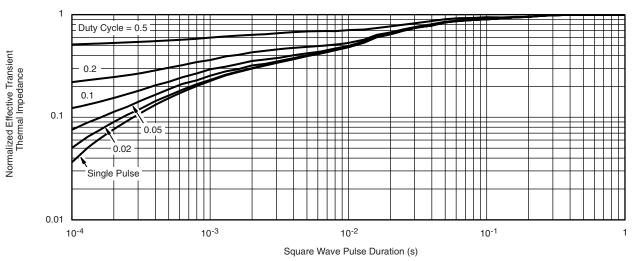
^{**} The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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Document Number: 65717 S12-1958-Rev. C, 13-Aug-12 For technical questions, contact: pmostechsupport@vishay.com



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